COMPLIANT

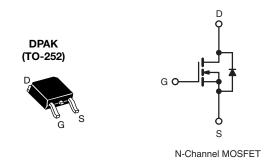
HALOGEN FREE

www.vishay.com

Vishay Siliconix

E Series Power MOSFET

PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	650		
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.6		
Q _g max. (nC)	40		
Q _{gs} (nC)	5		
Q _{gd} (nC)	9		
Configuration	Single		



FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION		
Package	DPAK (TO-252)	
Lead (Pb)-free and Halogen-free	SiHD7N60E-GE3	
	SiHD7N60ET1-GE3	
	SiHD7N60ET5-GE3	
	SiHD7N60ET4-GE3	

PARAMETER			SYMBOL	LIMIT	UNIT
Durin On the Welling			V _{DS}	600	
Drain-Source Voltage	T _C = -25 °C	$T_C = -25 ^{\circ}\text{C}, I_D = 250 \mu\text{A}$		575	V
Gate-Source Voltage			V _{GS}	± 30	
Continuous Drain Current /T 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		7	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	5	Α
Pulsed Drain Current ^a		I _{DM}	18		
Linear Derating Factor				0.63	W/°C
Single Pulse Avalanche Energy b		E _{AS}	43	mJ	
Maximum Power Dissipation			P _D	78	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		d\//d+		1//20
Reverse Diode dV/dt ^d		dV/dt	3	V/ns	
Soldering Recommendations (Peak Temperature) c	rure) c for 10 s			300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 13.8 \,\text{mH}$, $R_g = 25 \,\Omega$, $I_{AS} = 2.5 \,\text{A}$.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	1.6	C/VV

PARAMETER	SYMBOL	OL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-				·	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	609	-	-	٧
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.68	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	2	-	4	٧
		\	V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	\	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
		V _{DS} =	600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}		, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V			0.5	0.6	Ω
Forward Transconductance	9 _{fs}		= 50 V, I _D = 3.5 A	-	1.9	-	S
Dynamic	-			L			
Input Capacitance	C _{iss}		V _{GS} = 0 V,		680	-	
Output Capacitance	Coss	Τ ,	$V_{DS} = 100 \text{ V},$	-	39	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	5	-	1
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		-	34	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	100	-	
Total Gate Charge	Qg			-	20	40	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 3.5 \text{ A}, V_{DS} = 480 \text{ V}$		-	5	-	nC
Gate-Drain Charge	Q_{gd}			-	9	-	
Turn-On Delay Time	$t_{d(on)}$	V _{DD} = 480 V, I _D = 3.5 A,		-	13	26	
Rise Time	t _r			-	13	26	ns
Turn-Off Delay Time	$t_{d(off)}$	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		24	48	113
Fall Time	t _f			-	14	28	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		-	1.1	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7	
Pulsed Diode Forward Current	I _{SM}			-	-	18	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 3.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _{S = 3.5 A} , dI/dt = 100 A/ μ s· V_R = 20 V		-	230	-	ns
Reverse Recovery Charge	Q _{rr}			-	1.9	-	μC
Reverse Recovery Current	I _{RRM}			_	14	_	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

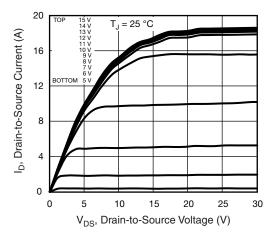


Fig. 1 - Typical Output Characteristics

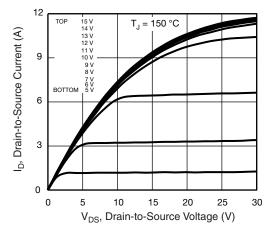


Fig. 2 - Typical Output Characteristics

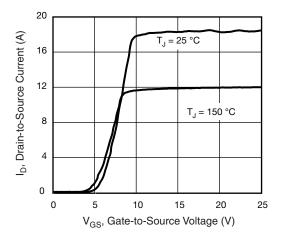


Fig. 3 - Typical Transfer Characteristics

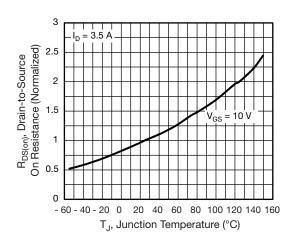


Fig. 4 - Normalized On-Resistance vs. Temperature

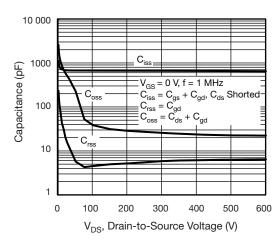


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

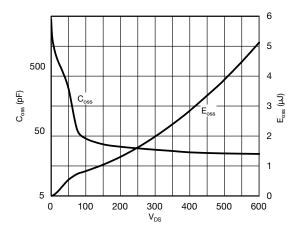


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



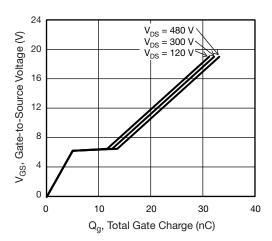


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

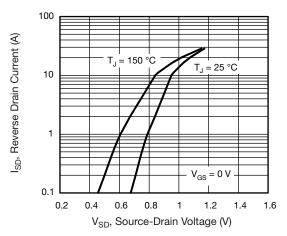


Fig. 8 - Typical Source-Drain Diode Forward Voltage

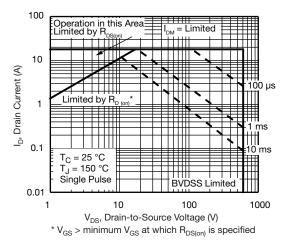


Fig. 9 - Maximum Safe Operating Area

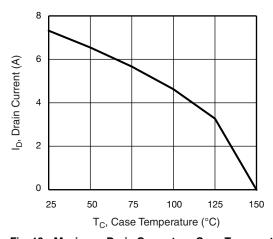


Fig. 10 - Maximum Drain Current vs. Case Temperature

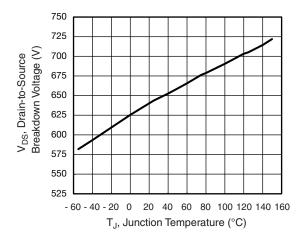


Fig. 11 - Temperature vs. Drain-to-Source Voltage



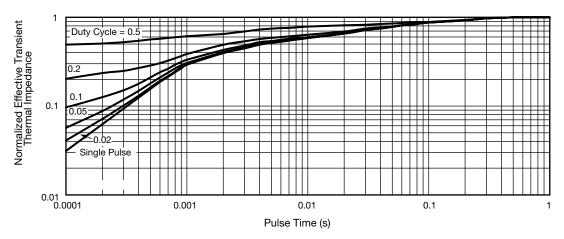


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

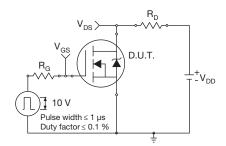


Fig. 13 - Switching Time Test Circuit

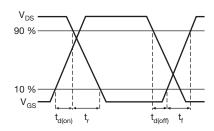


Fig. 14 - Switching Time Waveforms

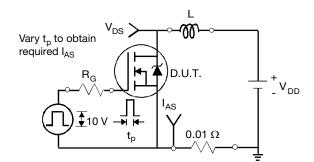


Fig. 15 - Unclamped Inductive Test Circuit

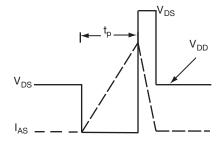


Fig. 16 - Unclamped Inductive Waveforms

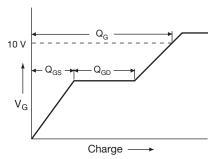


Fig. 17 - Basic Gate Charge Waveform

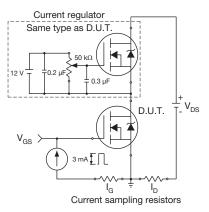
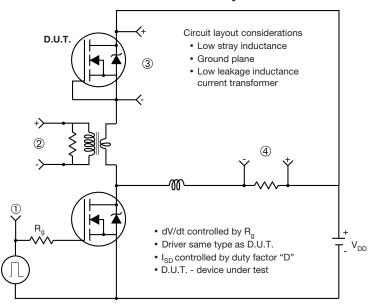


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



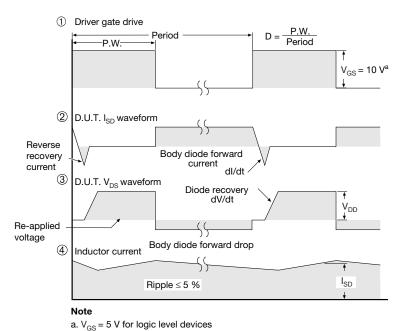


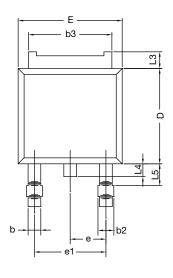
Fig. 19 - For N-Channel

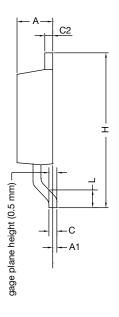
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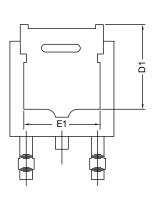


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







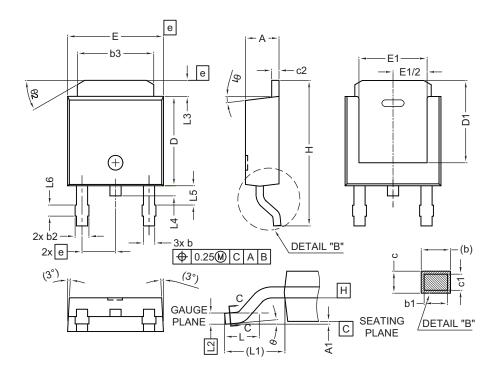
	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	=	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
Е	6.35	6.73	
E1	4.32	-	
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ł ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022

DWG: 5347



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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